

SPECIFICATIONS

CUSTOMER . HJP032

SAMPLE CODE . SC1602LRS-HWA-B-Q

MASS PRODUCTION CODE . PC1602LRS-HWA-B-Q

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 001

DRAWING NO. (Ver.) . JLMD-PC1602LRS-HWA-B-Q _001

PACKAGING NO. (Ver.) JPKG -PC1602LRS-HWA-B-Q _001

Customer Approved

Date:

POWERTIP
2013.03.01

JS RD APPROVED

Approved	Checked	Designer
門 偉	劉進	李誠
Ryan	lori	Bruce

- Preliminary specification for design input
- Specification for sample approval

POWERTIP TECH. CORP.

Headquarters: No.8, 6th Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8號

TEL: 886-4-2355-8168

FAX: 886-4-2355-8166

E-mail: sales@powertip.com.tw
Http://www.powertip.com.tw



RECORDS OF REVISION

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
11/6/2001	01	0	PC1602LRS-HWA-B-Q is the ROHS compliant part number based on Powertip's standard PC1602LRS-HWA-B	-	
4/15/2002	01	A	Update Timing Characteristics and Display Command	12,14	
2/24/2013	01	001	Revise Darwing	Appendix	Bruce
		X			

Total: 28 Pages



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
- 2.4 Display Command
- 2.5 Character Pattern

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix: LCM Drawing

Packaging



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	16*2 characters
LCD Type	STN, Gray, Transflective, Positive, Normal Temp.
Driver Condition	LCD Module: 1/16 Duty, 1/4 Bias
Viewing Direction	6 O'clock
Backlight	Yellow-Green LED B/L
Interface	-
Other(controller / driver IC)	ST7066U,KS0065B
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news/LatestNews.asp

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	85.0(L) *36.0(w) * 14.5(H)Max	mm
Viewing Area	66.0(L) *16.0 (w)	mm
Active Area	56.21(L) *11.5(w)	mm
Character Size	0.56(L) *0.66(w)	mm
Character Pitch	0.60(L) *0.70(w)	mm

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	-	-0.3	7.0	V
LCD Driver Supply Voltage	V_{LCD}	-	VDD-10.0	V _{DD} +0.3	V
Input Voltage	V_{IN}	-	-0.3	V _{DD} +0.3	V
Operating Temperature	T_{OP}	-	0	50	$^{\circ}\mathbb{C}$
Storage Temperature	T_{ST}	-	-20	70	$^{\circ}\!\mathbb{C}$
Storage Humidity	H_D	Ta $<$ 40 $^{\circ}$ C	-	90	%RH



1.4 DC Electrical Characteristics

 V_{DD} =5.0 ± 0.5V , V_{SS} = 0V , Ta = 25°C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	$V_{ m DD}$	-	4.5	5	5.5	V
"H" Input Voltage	V_{IH}	-	0.7 Vdd	-	V _{DD}	V
"L" Input Voltage	$V_{ m IL}$	-	-0.3	-	0.6	V
"H" Output Voltage	V_{OH}	IOH=-0.1mA	3.9	-	V_{DD}	V
"L" Output Voltage	V_{OL}	IOL=+0.1mA	-	-	0.4	V
Supply Current	I _{DD} *1	V _{DD} =5.0V	-	1.5	3.0	mA
		0℃				
LCM Driver Voltage	V _{OP} *2	25°C	4.0	4.2	4.4	V
		50 °C				

NOTE: *1 The Maximum current display

*2 The VOP test point is VDD-V0





1.5 Optical Characteristics

LCD Panel: 1/16 Duty, 1/4Bias, $V_{LCD} = 4.2$ V, Ta = 25°C

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr		-	150	-	ms	Note2
Response Time	Fall	tf		-	300	-		Note2
	Top ΘY+ C>2.0,		C>2.0,	40	-	-		\$
Viewing angle	Bottom	ΘΥ-	Ø = 270°	40	_	-	Deg.	Note 1
range	Left	ΘX-		45	4	-		
	Right	ΘX+		45	-	-		
Contrast Rat	io	С	$\theta = 0^{\circ},$ $\emptyset = 270^{\circ}$	5	7	1	_	Note 3

Note 4 :

 $1 : \triangle B = B(min) / B(max) * 100\%$

2 : Measurement Condition for Optical Characteristics:

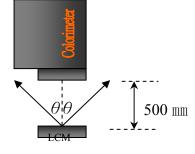
a : Environment: 25° C $\pm 5^{\circ}$ C $/60\pm 20\%$ R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency

b: Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation

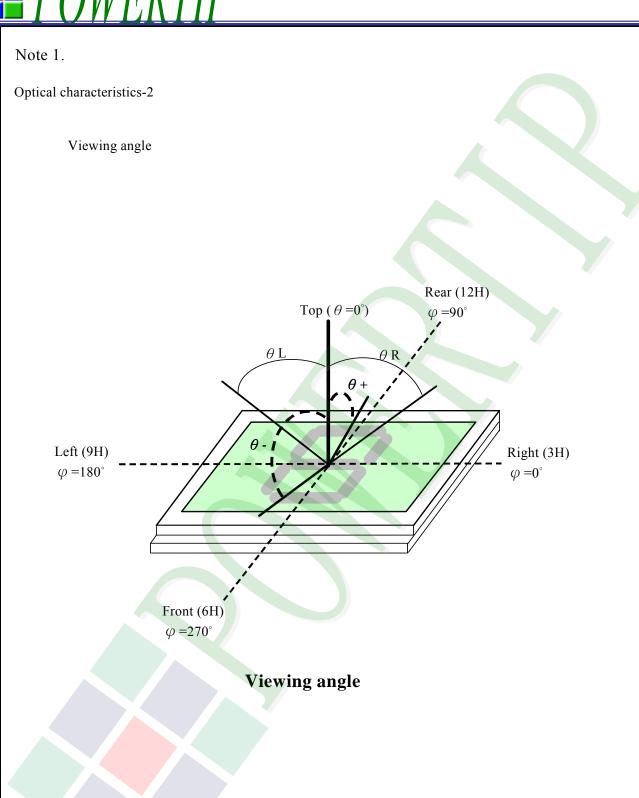
d : The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm~4\%$



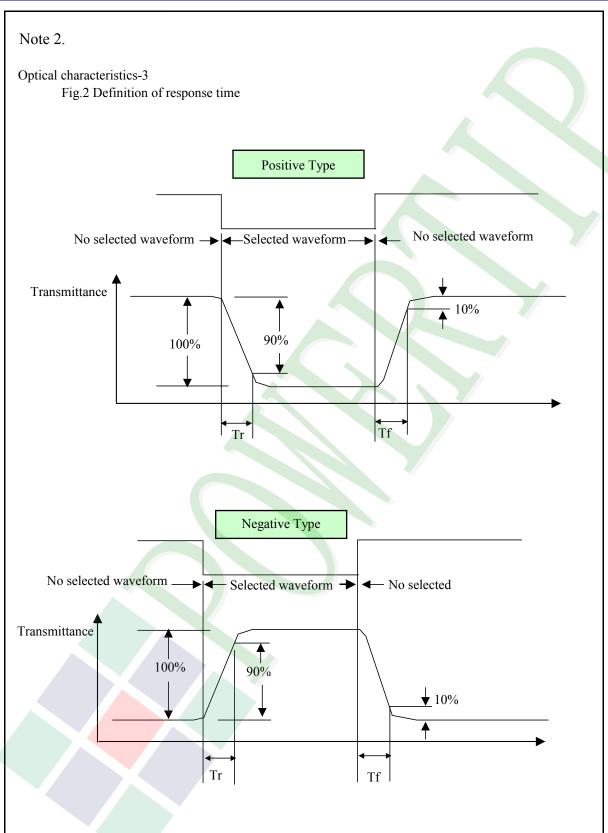


Colorimeter=BM-7 fast











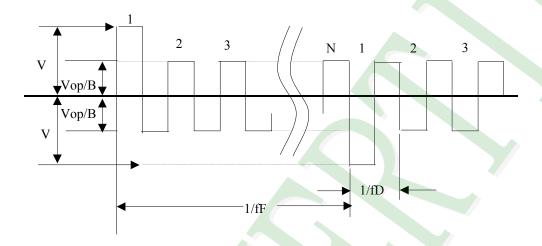
Electrical characteristics-2

※2 Drive waveform

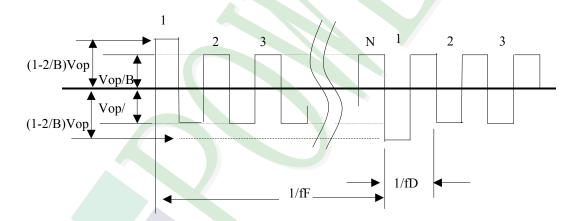
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



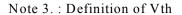
(2) Non- Selected wave form

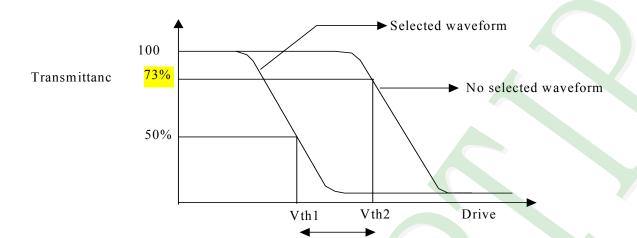


Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period







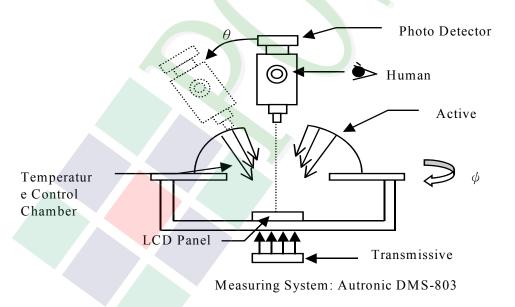
Active voltage range

_	Vth1	Vth2
View direction	10°	40 °
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

★1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System



1.6 Backlight Characteristics



LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°℃		300	mA
Reverse Voltage	VR	Ta =25°℃	-	8	V
Power Dissipation	РО	Ta =25°℃		1.38	W

Electrical / Optical Characteristics

Ta =25°℃

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF= 120mA	-	4.2	4.6	V
Reverse Current	IR	VR=8V		-	0.2	mA
Average Brightness (without LCD)	Iv	IF= 120mA	120	150	-	
Wavelength	Hue	IF=120mA	569	-	576	nm
Color	Yellow-Green					





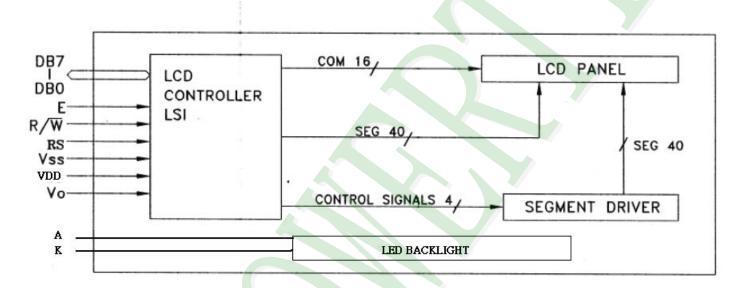
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



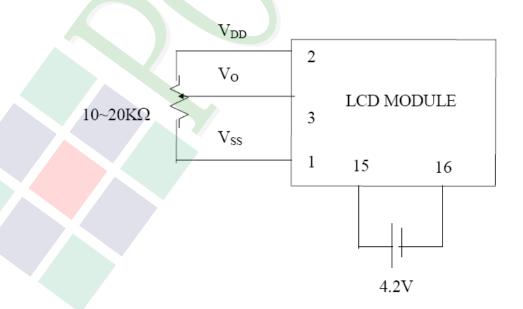




2.2 Interface Pin Description

Pin No.	Symbol	Signal Description
1	Vss	Power Supply (V _{SS} =0)
2	Vdd	Power Supply (V _{DD} >V _{SS})
3	Vo	Operating voltage for LCD.
4	RS	Register Selection input. High = Data register; Low = Instruction register (for write). Busy flag address counter (for read)
5	R/W	Read/Write signal input is used to select the read / write mode High = Read mode, Low = Write mode
6	Е	Start enable signal to read or write the data
7~10	DB0~DB3	Four low order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCD module. These four are not used during 4-bit operation.
11~14	DB4~DB7	Four high order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCD module. DB7 can be used as a busy flag.
15	A	Power supply for LED backlight (+)
16	K	Power supply for LED backlight (-)

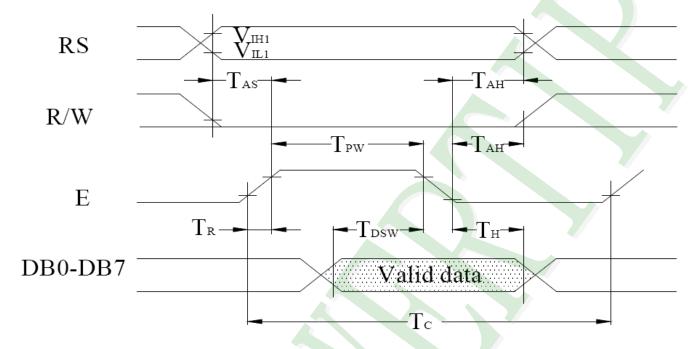
Contrast Adjust



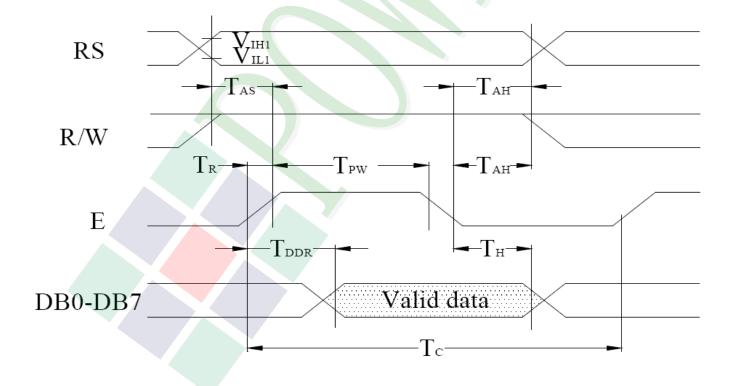


2.3 Timing Characteristics

• Writing data from MPU to ST7066U



• Reading data from ST7066U to MPU





• Write Mode (Writing data from MPU to ST7066U)

(VDD=+5V±10%,Ta=25°C)

				. `		
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
$T_{\rm C}$	Enable Cycle Time	Pin E	1200	- (-	ns
T_{PW}	Enable Pulse Width	Pin E	140		-	ns
T_R , T_F	Enable Rise / Fall Time	Pin E	-	A	25	ns
T _{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T_{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T _{DSW}	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
T _H	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

• Read Mode (Reading data from ST7066U to MPU)

 $(V_{DD} = +5V + 10\%, Ta = 25^{\circ}C)$

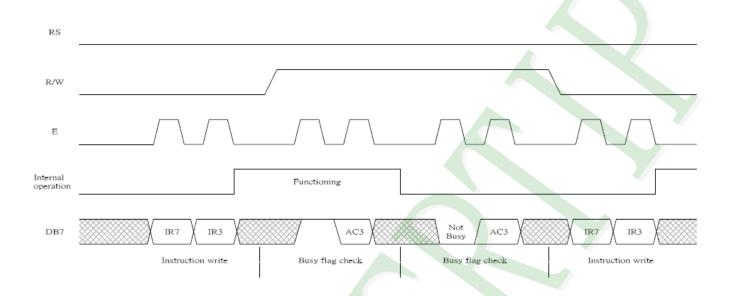
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
$T_{\rm C}$	Enable Cycle Time	Pin E	1200	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R , T_F	Enable Rise / Fall Time	Pin E	- /	-	25	ns
T _{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T_{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T_{DDR}	Data Setup Time	Pins:DB0~DB7	-	-	100	ns
T_{H}	Data Hold Time	Pins:DB0~DB7	10	-	-	ns





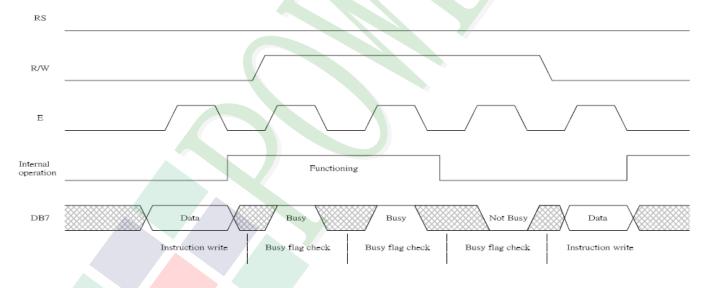
For 4-bit interface date, only four bus lines (DB4 to DB7) are used for transfer.

Example of busy flag check timing sequence



For 8-bitinterface date, all eight bus lines (DB0 to DB7) are used

Example of busy flag check timing sequence





2.4 Display Command

Instruction Table:

				Inst	ructi	on (Code	•				Description
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	Time (270KHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC	1.52 ms
Return Home	0	0	0	0	0	0	0	0	1	x	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37 us
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	D=1:entire display on C=1:cursor on B=1:cursor position on	37 us
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	х	x	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	37 us
Function Set	0	0	0	0	1	DL	N	F	х	x	DL:interface data is 8/4 bits N:number of line is 2/1 F:font size is 5x11/5x8	37 us
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	37 us
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	37 us
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 us
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM)	37 us
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM)	37 us

Note:

Be sure the ST7066U is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.



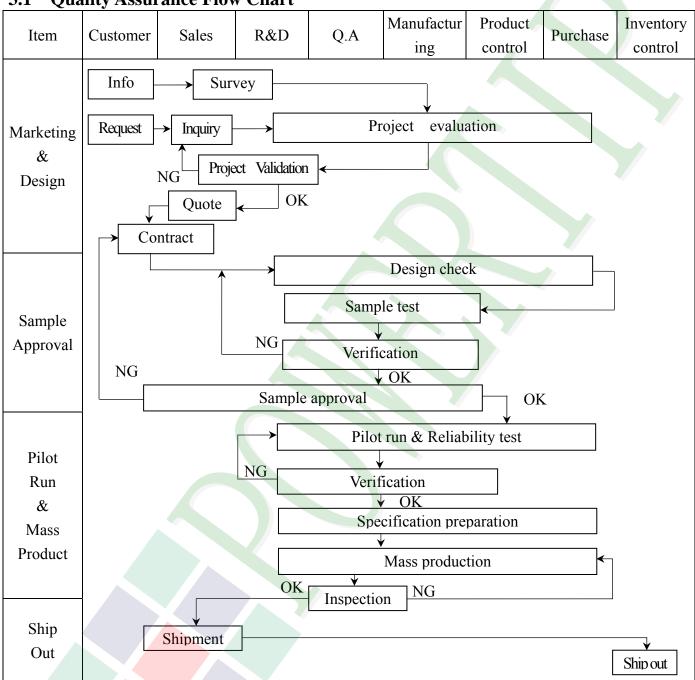
2.5 Character Pattern

67-64 63-60	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	(7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

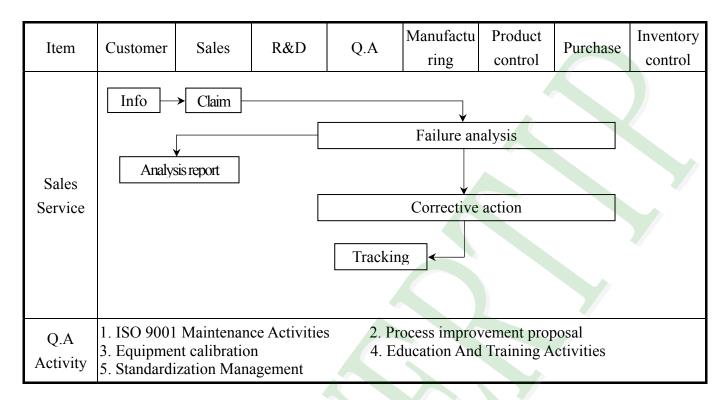


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).
- ♦Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge \ MIL-STD \ Powertip Tester \ Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- **♦**OUT Going Defect Level : Sampling .
- **◆**Manner of appearance test :
 - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). Standard of inspection: (Unit: mm)
 - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (4). Definition of area . (Fig. 2)

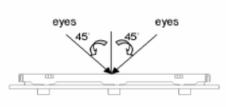


Fig.1

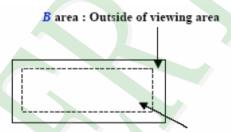


Fig. 2 A area: viewing area

Specification:

NO	Item	Criterion	Level
		1. 1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1.2 Mixed production types.	Major
		1. 3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
		4. 2 No function or no display.	Major
04	Electrical Testing	4. 3 Output data is error.	Major
		4. 4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major



♦ Sp	ecification For Mono	type and Color STN: (Ve						
NO	Item		C	riterio	on			Level
	Black or white dot \ scratch \ contamination	4 white	_	esent.				
		5. 1. 2 Non-						
	Round type		Dimension (diameter : Φ)		Acceptance			
	.1. 1.	,	$\Phi \leq 0.10$		A area	В	area	
	→ <u>x</u>	0.10 <		3				
05	<u> </u>	0. 20 <		2 Ignore		gnore	Minor	
	$\Phi = (x+y)/2$		Total quantity		4			
	Ψ (x+y)/2							
		5. 1. 3 Line type:						
	Ŧ	Dimension		Acceptan		otanc	e (Q'ty)	
	Line type	Length (L)	Width (W)		A area		B area	
	✓ / ¥ w		W ≤ (0. 03	Accept no de	nse		
	·	L ≤ 3. 0	$0.03 < \mathbf{W} \le 0$	0. 05	4		Ignore	
	L	$L \leq 2.5$	$0.05 < W \le 0.$	075	4			
			W > 0	075	As	roun	d type	
			nension		Acceptan	ce (Q		
		(diam	eter : Φ)		A area		B area	
06		$\Phi \leq 0.20$			Accept no dense			
	Polarizer	0.20 <	$\Phi \leq 0.50$		3			Minor
	Bubble	0.50 <	$\Phi \leq 1.00$		2		Ignore	
			$\Phi > 1.00$		0			
					\neg			

Total quantity



◆Specification For Monotype and Color STN:

(Ver.B01)

NO	Item	Criterion		Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of Crack W: terminal length of Crack a: LCD side length	gth	
		7. 1 General glass chip: 7. 1. 1 Chip on panel surface and crack between panels	iels:	
		Y Z Z	Y	
07	The crack of glass	SP SP NG	:	Minor
		Seal width		
		X Y Z		
		≤ a Crack can't enter viewing area ≤1/	′2 t	
4		≤ a Crack can't exceed the half of SP width. 1/2 t <	Z ≤2 t	



Spec	ification For Mo	otype and Color S	TN:				(Ver. B01)
NO	Item	T		Criterion			Level
		Symbols: X: The length of Z: The thickness t: The thickness 7. 1. 2 Corner c	ss of crack s of glass	W : ter	e width of crack. minal length D side length		
		X ≤1/5 a	Crack ca	n't enter g area	Z		
0.7	The crack of	≤1/5 a	Crack can' half of S	t exceed the P width.	1/2 t < Z ≤	2 t	35.
07	glass	7.2 Protrusion 7.2.1 Chip on					Minor
		WY	X	X	Z W		
			X	Y	Z		
		Front	≦ a	$\leq 1/2 \text{ W}$	≦ t		

Back

Neglect



◆Specification For Monotype and Color STN: (Ver. B01)

NO	Item	Criterion	Level
		Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length	
07	The crack of glass	7. 2. 2 Non-conductive portion: X	Minor



◆Specification For Monotype and Color STN:

(Ver. B01)

NO	Item	Criterion	Level
		8. 1 Backlight can't work normally.	Major
08	Backlight elements	8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
		9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
4		9.4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

Reliability Test Condition (Ver.B01)

2 Low Temperature Storage Test High Temperature / High Humidity Storage Test Temperature Cycling Storage Test Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- ESD Test ESD Test Keep in -20 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4 (Excluding temperature, then storage at normal condition 4 (Excluding the polarizer) -20(min) → +25°C → 70(max) → +25°C (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4 Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- Discharge Capacitance (Cs+Cd): 150pF±10% Light Temperature ambiance: 15°C ~35°C Light Humidity relative: 30% ~60% Senergy Storage Capacitance (Cs+Cd): 150pF±10% Light Temperature ambiance: 15°C ~35°C Light Tempe	NO.	TEST ITEM	TEST CONDITION					
Storage Test Surrounding temperature, then storage at normal condition 4	1	_	Keep in +70 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.					
3 High Humidity Storage Test Surrounding temperature, then storage at normal condition 4 (Excluding the polarizer) 4 Temperature Cycling Storage Test Compare the storage at normal condition 4 (Excluding the polarizer) 4 Temperature Cycling Storage Test Compare the storage at normal condition 4 (Excluding temperature, then storage at normal condition 4 (Excluding the polarity + (Excluding temperature, then storage at normal condition 4 (Excluding the polarity + (Exc	2		Keep in −20 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.					
Temperature Cycling Storage Test (30mins) (5mins) (30mins) (5mins) (10 Cycle Surrounding temperature, then storage at normal condition 4 (20mins) (20min	3	High Humidity	Surrounding temperature, then storage at normal condition 4hrs.					
Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: 15°C ~35°C 2. Humidity relative: 30% ~60% 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge Resistance(Rd): 330Ω±10% 5. Discharge, mode of operation: Single Discharge (time between successive discharges at lease (Tolerance if the output voltage indication: ±5%) 1. Sine wave 10~55 Hz frequency (1 min/sweep) 2. The amplitude of vibration: 1.5 mm 3. Each direction (X × Y × Z) duration for 2 Hrs Packing Weight (Kg) Drop Height (cm) 0 ~ 45.4 122 45.4 ~ 90.8 76	4	•	(30mins) (5mins) (5mins)					
7 Vibration Test (Packaged) 2. The amplitude of vibration :1. 5 mm 3. Each direction (X \cdot Y \cdot Z) duration for 2 Hrs Packing Weight (Kg) Drop Height (cm) 0 ~ 45. 4 122 45. 4 ~ 90. 8 76	5	ESD Test	Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: $15^{\circ}\text{C} \sim 35^{\circ}\text{C}$ 2. Humidity relative: $30\% \sim 60\%$ 3. Energy Storage Capacitance(Cs+Cd): $150\text{pF}\pm10\%$ 4. Discharge Resistance(Rd): $330\Omega\pm10\%$ 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec)					
7 Drop Test 45. 4 ~ 90. 8 76	6		2. The amplitude of vibration :1.5 mm					
Over 454 46 Drop Direction: **1 corner / 3 edges / 6 sides each 1 time	7	_	0 ~ 45. 4 122 45. 4 ~ 90. 8 76 90. 8 ~ 454 61 Over 454 46					



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

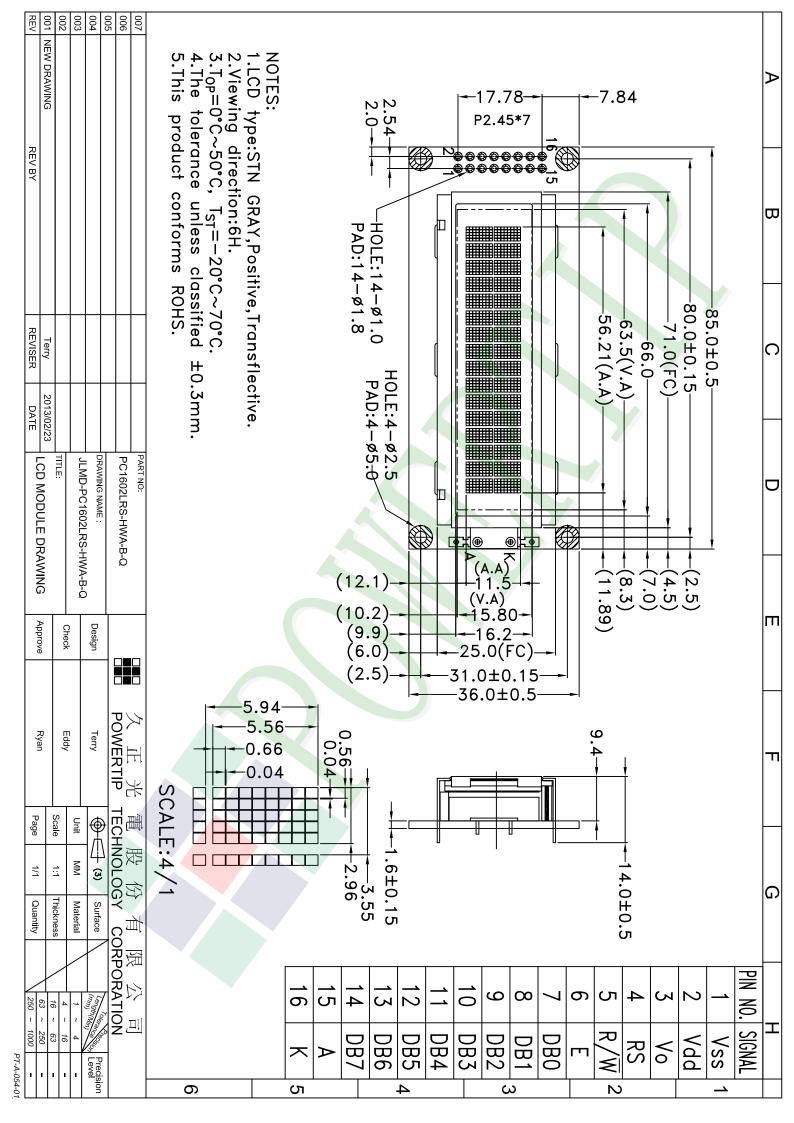
- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

PC1602LRS-HWA-B-Q Page28 SAMPLE Ver.01 SPEC Edi.001



Approve Check Contact Ver.001 LCM包裝規格書 Documents NO. JPKG-PC1602LRS-HWA-B-Q Eddy LCM Packaging Specifications Ryan Terry 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Total Weight Quantity 1 成品 (LCM) PC1602LRS-HWA-B-Q 85X36X14.5 0.034 432 14.688 2 靜電袋(1)Antistatic Bag BAG100100ARABA 100 X 100 0.0011 432 0.4752 3 A1-1隔板(3)A1-1 Partition 295 X 47 X 3 1.3104 0.0078 168 BX29500047BZBA 4 B1-1隔板(4)B1-1 Partition 245 X 47 X 3 0.0065 0.312 BX24500047BZBA 48 5 氣泡紙(5)Bubble Sheet BAG280240BWABA 280 X 240 0.006 24 0.144 6 C1內盒(6)Product Box 12. 1.56 BX31025555AABA 310 X 255 X 55 0.13 7 外紙箱(7)Carton BX52732536CCBA 527 X 325 X 360 0.83 0.83 8 9 2.一整箱總重量 (Total LCD Weight in carton): 19.32 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)Quantity Of Spacer: A1-1隔板 X 14 , B1-1隔板 X (2)Total LCM quantity in carton: quantity per box x no of boxes 12 468 (5) 氣泡紙 **Bubble Sheet** (1)靜電袋+LCM Antistatic Bag+LCM (4) B1-1隔板 B1-1 Partition (3) A1-1隔板 À1-1 Partition ᆥ (5) 氣泡紙 **Bubble Sheet** 11 (7)外紙箱 Carton (6) C1內盒 Product Box 特 記 事 項 (REMARK) 4. Label Specifications: 5. LCM排放示意圖(前中後間隔不放置): 5. LCM placed as figure showing: (First and last slot should be empty) TYPE ID.NO S/0

模組(LCM) X 1pcs.

Q'TY

Lot.NO Note Pcs Date

參照"成品包裝點檢作業標準書"內容